



US00RE38651E

(19) **United States**
(12) **Reissued Patent**
Sung et al.

(10) **Patent Number: US RE38,651 E**
(45) **Date of Reissued Patent: Nov. 9, 2004**

(54) **VARIABLE DEPTH AND WIDTH MEMORY DEVICE**

4,593,373 A * 6/1986 Kiuchi et al. 364/736
4,609,986 A * 9/1986 Hartmann et al. 326/45

(List continued on next page.)

(75) Inventors: **Chiakang Sung**, Milpitas, CA (US);
Wanli Chang, Saratoga, CA (US);
Joseph Huang, San Jose, CA (US);
Richard G. Cliff, Milpitas, CA (US);
L. Todd Cope, San Jose, CA (US);
Cameron R. McClintock, Mountain View, CA (US); **William Leong**, San Francisco, CA (US); **James A. Watson**, Santa Clara, CA (US); **Bahram Ahanin**, Cupertino, CA (US)

FOREIGN PATENT DOCUMENTS

DE 25 15 696 * 4/1975
EP 0 156 316 * 10/1985
JP 2-108168 * 4/1990

OTHER PUBLICATIONS

William I. Fletcher et al., "Simplify Sequential Circuit Designs", *Electronic Design*, Jul. 1971, pp. 70-72.*
R. C. Minnick, "A Survey of Microcellular Research," *Journal of the Association for Computing Machinery*, vol. 14, No. 2, pp. 203-241, Apr. 1967.
S. E. Wahlstrom, "Programmable Logic Arrays—Cheaper by the Millions," *Electronics*, Dec. 11, 1967, pp. 90-95.

(List continued on next page.)

(73) Assignee: **Altera Corporation**, San Jose, CA (US)

(21) Appl. No.: **09/096,917**

(22) Filed: **Jun. 12, 1998**

Related U.S. Patent Documents

Reissue of:

(64) Patent No.: **5,717,901**
Issued: **Feb. 10, 1998**
Appl. No.: **08/555,109**
Filed: **Nov. 8, 1995**

Primary Examiner—B. James Peikari
(74) *Attorney, Agent, or Firm*—Fish & Neave

(57) **ABSTRACT**

A programmable variable depth and width random-access memory circuit is provided. The memory circuit contains rows and columns of memory cells for storing data. A row decoder is used to address individual rows of the memory cells. Column address circuitry receives a column address signal and a width and depth selection signal. A column decoder within the column address circuitry addresses one or more columns of memory cells of the RAM array based on the selected width of the array. The output of the column decoder is routed to the appropriate column or columns of memory cells by a pattern of fixed connections and a group of programmable multiplexers. The number of data output lines to which data signals are provided is determined by the selected width of the RAM array. The output circuitry contains a group of programmable demultiplexers and a routing array having a pattern of fixed connections suitable for passing data signals from the RAM array to the selected number of data output lines.

U.S. Applications:

(63) Continuation-in-part of application No. 08/442,795, filed on May 17, 1995, now Pat. No. 5,689,195, and a continuation-in-part of application No. 08/245,509, filed on May 18, 1994, now Pat. No. 5,550,782.

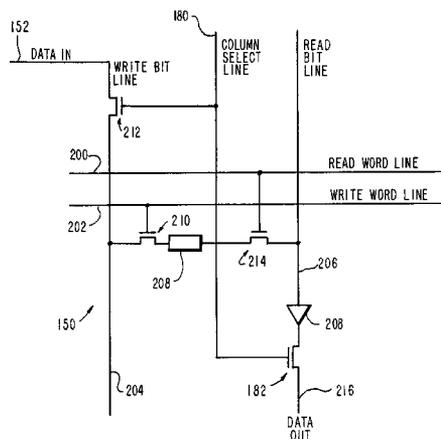
(51) **Int. Cl.**⁷ **G06F 12/00**
(52) **U.S. Cl.** **711/170**; 711/171; 711/150;
365/230.02; 326/38; 326/39; 326/40; 326/41
(58) **Field of Search** 326/38, 39, 40,
326/41; 711/105, 170, 171, 172, 212, 150;
709/233; 710/52, 58, 60; 365/189.05, 230.02,
230.08

(56) **References Cited**

U.S. PATENT DOCUMENTS

3,473,160 A * 10/1969 Wahlstrom 227/100

15 Claims, 4 Drawing Sheets



U.S. PATENT DOCUMENTS

4,617,479	A	*	10/1986	Hartmann et al.	365/185.17
4,642,487	A	*	2/1987	Carter	326/41
4,677,318	A	*	6/1987	Veenstra	326/40
4,713,792	A	*	12/1987	Hartmann et al.	395/430
4,751,671	A	*	6/1988	Babetski et al.	395/250
4,758,745	A	*	7/1988	Elgamal et al.	326/16
4,774,421	A	*	9/1988	Hartmann et al.	365/185.17
4,871,930	A	*	10/1989	Wong et al.	326/39
4,899,067	A	*	2/1990	So et al.	326/38
4,912,342	A	*	3/1990	Wong et al.	326/40
4,942,541	A	*	7/1990	Hoel et al.	395/115
4,975,601	A		12/1990	Steele		
5,027,326	A	*	6/1991	Jones	365/221
5,121,006	A	*	6/1992	Pedersen	326/38
5,128,559	A		7/1992	Steele		
5,146,428	A	*	9/1992	Tanimura	365/189.08
5,220,214	A	*	6/1993	Pedersen	326/46
RE34,363	E	*	8/1993	Freeman	326/38
5,258,668	A	*	11/1993	Cliff et al.	326/41
5,260,610	A	*	11/1993	Pedersen et al.	326/41
5,260,611	A	*	11/1993	Cliff et al.	326/39
5,274,581	A	*	12/1993	Cliff et al.	364/784
5,350,954	A	*	9/1994	Patel	326/39
5,371,422	A	*	12/1994	Patel et al.	326/41
5,396,608	A	*	3/1995	Garde	395/410
5,506,850	A	*	4/1996	Osann, Jr.	371/22.1
5,541,530	A		7/1996	Cliff et al.	326/41
5,543,732	A		8/1996	McClintock et al.	326/41
5,550,782	A		8/1996	Cliff et al.	365/230.03
5,592,106	A		1/1997	Leong et al.	326/41
5,614,840	A		3/1997	McClintock et al.	326/41

OTHER PUBLICATIONS

Recent Developments in Switching Theory, A. Mukhopadhyay, ed., Academic Press, New York, 1971, chapters VI and IX, pp. 229–254 and 369–422.

El Gamal et al., “An Architecture for Electrically Configurable Gate Arrays,” *IEEE Journal of Solid-State Circuits*, vol. 24, No. 2, Apr. 1989, pp. 394–398.

El-Ayat et al., “A CMOS Electrically Configurable Gate Array,” *IEEE Journal of Solid-State Circuits*, vol. 24, No. 3, Jun. 1989, pp. 752–762.

“XC5000 Logic Cell Array Family, Technical Data, Advance Information,” Xilinx, Inc., Feb. 1995.

John L. Nichols, “A Logical Next Step for Read-Only Memories,” *Electronics*, Jun. 12, 1967, pp. 111–113.

Floyd Kvamme, “Standard Read-Only Memories Simplify Complex Logic Design,” *Electronics*, Jan. 5, 1970, pp. 88–95.

Albert Hemel, “Making Small ROM’s [sic] Do Math Quickly, Cheaply and Easily,” *Electronics*, May 11, 1970, pp. 104–111.

William I. Fletcher et al., “Simplify Sequential Circuit Designs,” *Electronic Design*, Jul. 8, 1971, pp. 70–72.

Howard A. Sholl et al., “Design of Asynchronous Sequential Networks Using Read-Only Memories,” *IEEE Transactions on Computers*, vol. C-24, No. 2, Feb. 1975, pp. 195–206.

Arnold Weinberger, “High-Speed Programmable Logic Array Adders,” *IBM J. Res. Develop.*, vol. 23, No. 2, Mar. 1979, pp. 163–178.

Yahiko Kambayashi, “Logic Design of Programmable Logic Arrays,” *IEEE Transactions on Computers*, vol. C-28, No. 9 Sep. 1979, pp. 609–617.

* cited by examiner

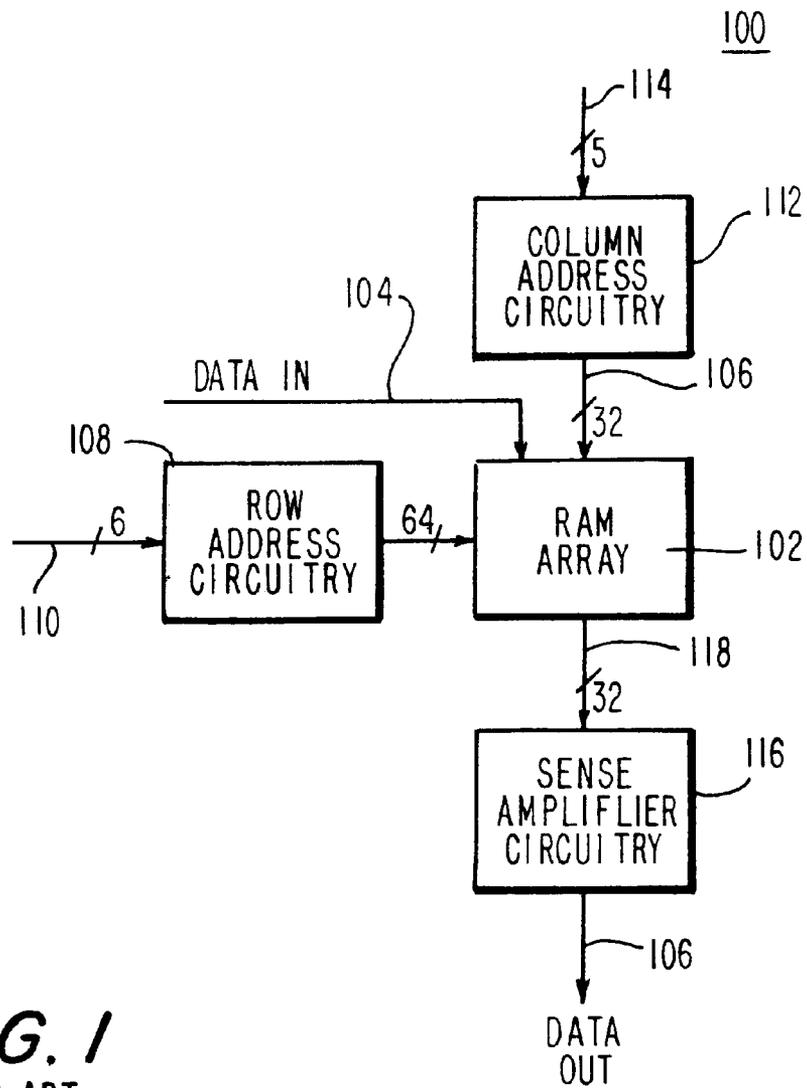


FIG. 1
PRIOR ART

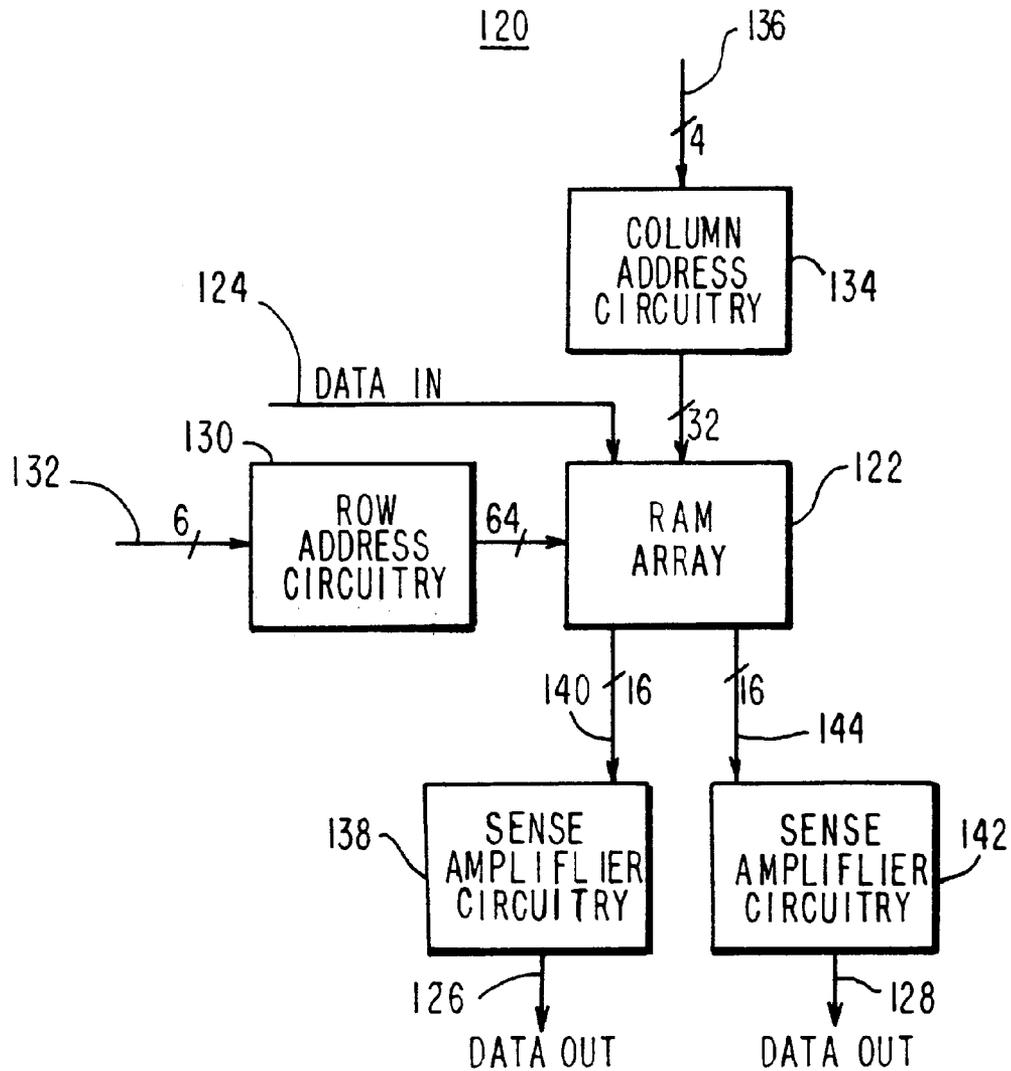


FIG. 2
PRIOR ART

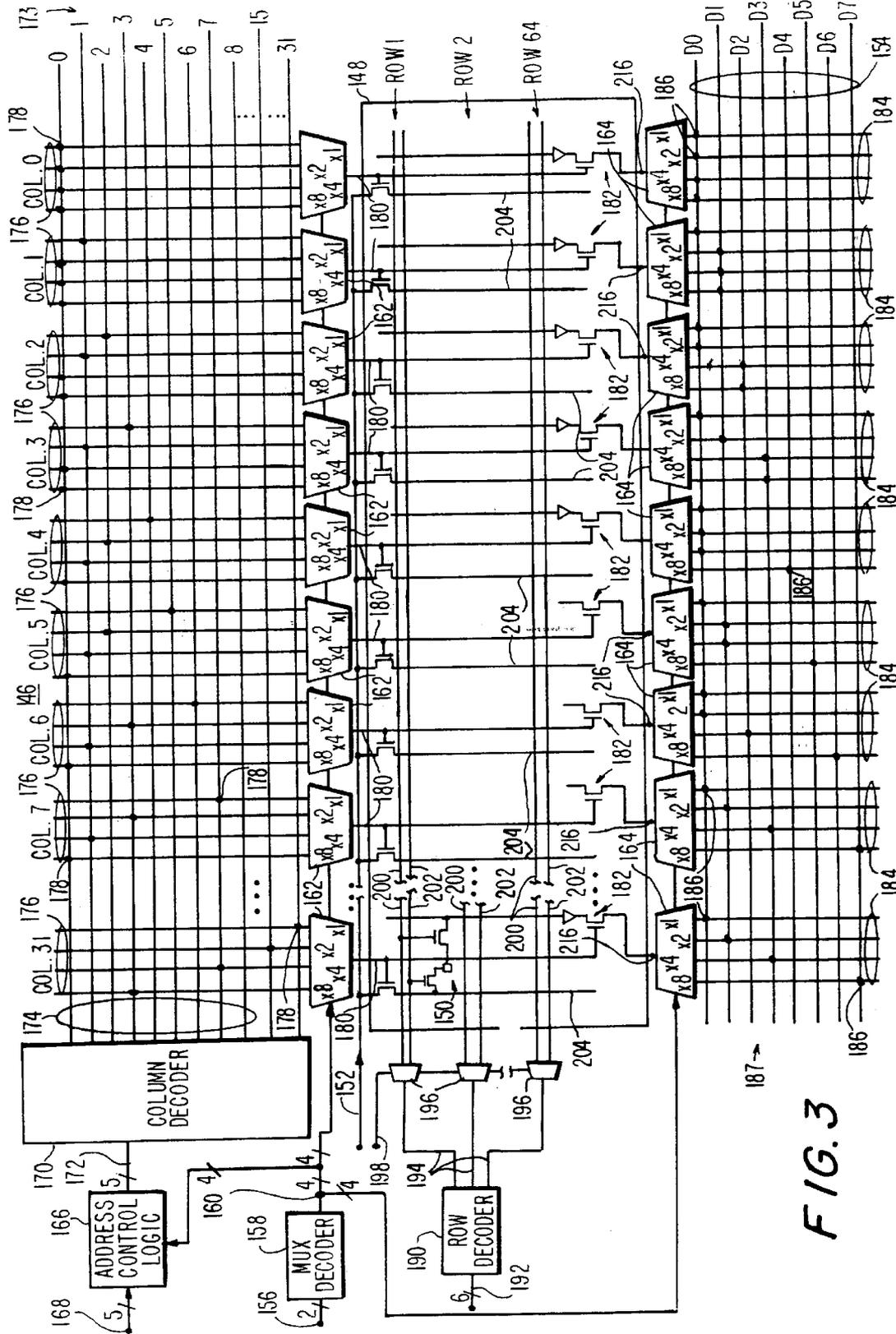


FIG. 3

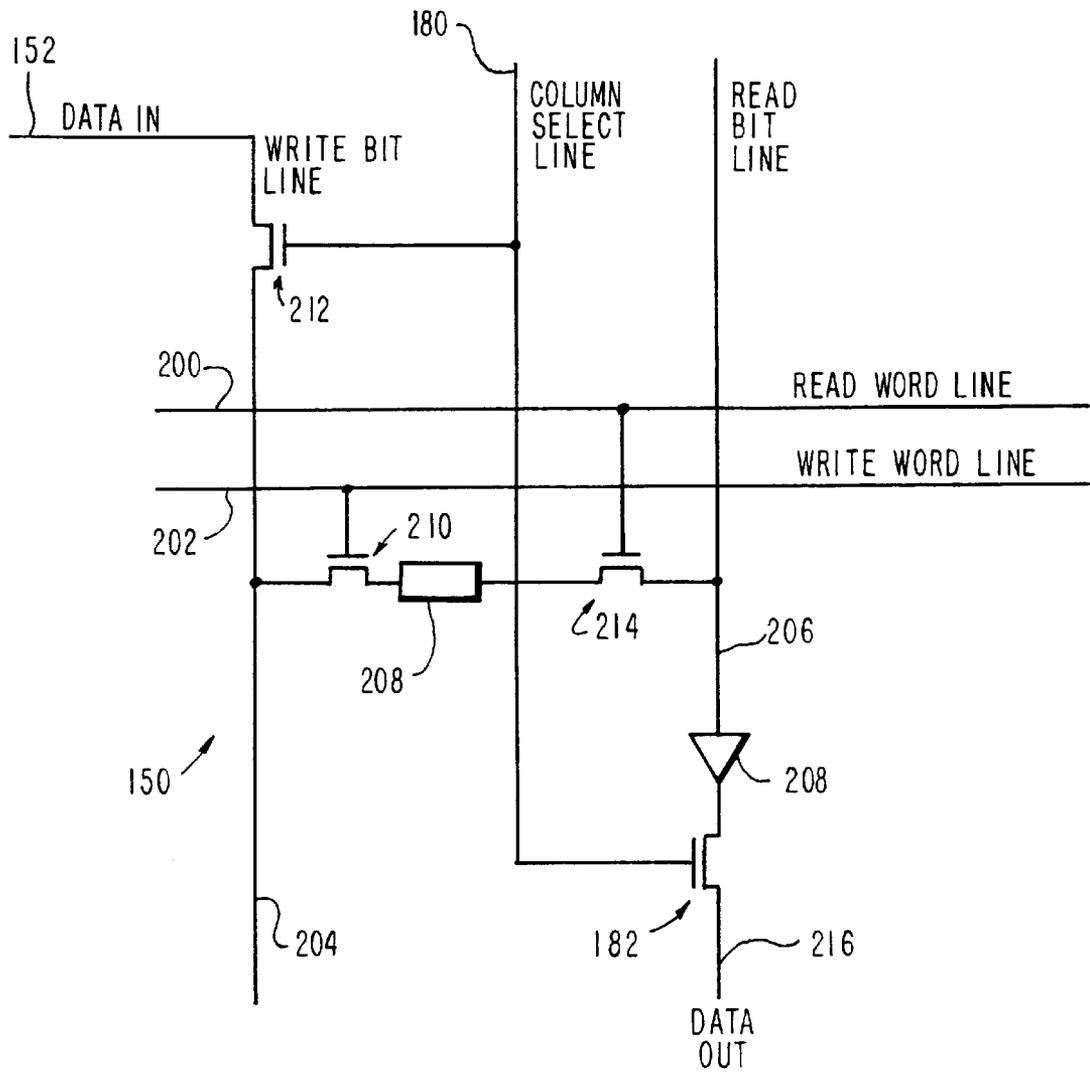


FIG. 4

VARIABLE DEPTH AND WIDTH MEMORY DEVICE

Matter enclosed in heavy brackets [] appears in the original patent but forms no part of this reissue specification; matter printed in italics indicates the additions made by reissue.

This application is a continuation-in-part of application Ser. No. 08/442,795, filed May 17, 1995, *now U.S. Pat. No. 5,689,195*, and a continuation-in-part of application Ser. No. 08/245,509, filed May 18, 1994, *now U.S. Pat. No. 5,550,782*.

BACKGROUND OF THE INVENTION

This invention relates to integrated circuit random access memory devices, and more particularly, to techniques for configuring the depth and width of a region of random access memory.

Integrated circuit random-access memory (RAM) devices are widely used in electronic systems. Such memory devices are typically characterized by a depth and a width. The width of a device is the number of parallel data output lines available for reading out data stored in the device. The depth of a device is the maximum number of data bits that may be accessed via each of the data output lines. For example, devices with a total storage capacity of two kilobits of data are available in 2K×1 and 1K×2 configurations. A 1K×2 device has a width of two and a depth of 1 kilobit (1024 bits). A 2K×1 device has a width of one and a depth of two kilobits.

Because random-access memory devices are available in various depth and width configurations, a designer of an electronic system is generally able to select a memory device with a depth and width suitable for use in the system. However, in some applications it would be **[desireable]** *desirable* to be able to reconfigure the depth and width of a selected memory device without having to use an entirely new part.

In addition, programmable logic devices sometimes contain regions of RAM, as described in commonly assigned co-pending Cliff et al. U.S. patent application Ser. No. 08/442,795, filed May 17, 1995, which is hereby incorporated by reference herein. Programmable logic devices can be programmed by a user to perform a variety of logic functions. To enhance the flexibility of a programmable logic device containing a region of RAM, it would be useful if were possible to program the region of RAM to various depth and width configurations.

Gate arrays sometimes contain blocks of RAM. If only part of the block of RAM is connected to the logic circuitry of the gate array during fabrication, the depth and width of the RAM that is used can be varied. For example, if a gate array contains a 2K×2 RAM array block, it is possible to fabricate the connections between the gate array logic circuitry and the RAM so that only a 2K×1 region of RAM is used. Alternatively, the gate array can be fabricated so that only a 1K×2 region is used. However, selectively connecting only portions of the block of RAM to the logic circuitry of the gate array is inefficient, because the portion of RAM that is not connected to the logic circuitry cannot be used. Further, because gate arrays are generally configured using custom masks, they are not field programmable and cannot be reconfigured after fabrication.

Some gate arrays, known as field programmable gate arrays, are reprogrammable. Field programmable gate arrays typically contain numerous configurable logic blocks, each

of which may contain a small amount of RAM. Although it might be possible to connect a number of the configurable logic blocks together to provide a large region of RAM, such an arrangement is unlikely to be satisfactory. The process of passing signals to and from a configurable logic block is relatively slow. Further, field programmable gate arrays do not contain row and column decoders for addressing RAM arrays. Although some decoding functions might be provided by the configurable logic blocks, using configurable logic blocks to build decoders would be cumbersome. Using the configurable logic blocks for decoding would also be slower than using dedicated row and column decoder circuitry.

It is therefore an object of the present invention to provide a programmable random-access memory circuit.

It is a further object of the present invention to provide a variable depth and width random-access memory circuit.

SUMMARY OF THE INVENTION

These and other objects of the invention are accomplished in accordance with the principles of the present invention by providing a programmable variable depth and width random-access memory circuit. The memory circuit contains rows and columns of memory cells for storing data. Row and column address circuitry is used to address the cells. Output circuitry is used to route data from the array to one or more data output lines.

The row address circuitry contains a row decoder. A row address signal is provided to the row decoder that causes the row decoder to address an individual row of memory cells in the array.

The column address circuitry receives a column address signal and a depth and width selection signal. A column decoder within the column address circuitry addresses one or more columns of memory cells in the RAM array based on the selected width of the array. The output of the column decoder is routed to the appropriate column or columns of memory cells by a routing array having a pattern of fixed connections and by a group of programmable multiplexers.

The number of data output lines to which data signals are provided is determined by the selected width of the RAM array. The output circuitry contains a group of programmable demultiplexers and a routing array having a pattern of fixed connections suitable for passing data signals from the RAM array to the selected number of data output lines.

If desired, the random-access memory circuit can be provided as part of a programmable logic device that uses programmable RAM or as part of any other suitable integrated circuit. The random-access memory circuit can also be provided as a discrete integrated circuit device.

Further features of the invention, its nature and various advantages will be more apparent from the accompanying drawings and the following detailed description of the preferred embodiments.

BRIEF DESCRIPTION OF THE DRAWINGS

FIG. 1 is a schematic diagram of a conventional 2K×1 memory device.

FIG. 2 is a schematic diagram of a conventional 1K×2 memory device.

FIG. 3 is a circuit diagram of a variable depth and width memory device in accordance with the present invention.

FIG. 4 is a circuit diagram of a memory cell of the memory device of FIG. 3.

DETAILED DESCRIPTION OF THE PREFERRED EMBODIMENTS

A conventional 2K×1 memory device **100** is shown in FIG. 1. Memory device **100** has a two kilobit random access memory (RAM) array **102**, which has 64 rows and 32 columns of memory cells (not shown). Data is written into the memory cells of array **102** using data input line **104**. Data is read out of the memory cells via data output line **106**. Row address circuitry **108** accepts a six bit address signal at input **110**, which allows row address circuitry **108** to address a selected one of the 64 rows of memory cells in array **102**. Column address circuitry **112** accepts a five bit address signal at input **114**, which allows column address circuitry **112** to address a selected one of the 32 columns of memory cells in array **102**.

Sense amplifier circuitry **116** receives 32 data output lines **118** from array **102**. Sense amplifier circuitry **116** amplifies the data received from array **102** on data output lines **118** and combines these 32 data output lines **118** to form output **106**. Because memory device **100** has a single output **106** and because the maximum amount of data that can be read out of output **106** is two kilobits, the memory device **100** is said to have a “depth” of 2K and a “width” of one. Because the depth and width of memory device **100** are fixed, if it is desired to use a memory configuration other than the 2K×1 RAM configuration of FIG. 1, memory device **100** cannot be used.

A conventional 1K×2 memory device **120** is shown in FIG. 2. Memory device **120** has a two kilobit RAM array **122**, which has 64 rows and 32 columns of memory cells (not shown). Data is written into the memory cells of array **122** using data input line **124**. Data is read out of the memory cells via two data output lines: data output line **126** and data output line **128**. Row address circuitry **130** accepts a six bit address signal at input **132**, which allows row address circuitry **130** to address a selected one of the 64 rows of memory cells in array **122**. Column address circuitry **134** accepts a four bit address signal at input **136**, which allows column address circuitry **134** to address a selected pair of the 32 columns of memory cells in array **122** (e.g., column **0** and column **16** or column **1** and column **17**).

Sense amplifier circuitry **138** receives 16 data output lines **140** from the first half of the columns of array **122** (e.g., columns **0** through **15**). Sense amplifier circuitry **142** receives 16 data output lines **144** from the second half of the columns of array **122** (e.g., columns **16** through **31**). Sense amplifier circuitry **138** amplifies the data received from array **122** on data output lines **140** and combines these 16 data output lines **140** to form the data output line **126**. Sense amplifier circuitry **142** amplifies the data received from array **122** on data output lines **144** and combines these 16 data output lines **144** to form data output line **128**. Addressing a pair of columns with column address circuitry **134** therefore causes the data from two associated memory cells of array **122** to be provided in parallel at data output lines **126** and **128**. The maximum amount of data that can be read out of either data output line **126** or data output line **128** is 1K. The memory device **120** therefore has a depth of 1K and a width of two. The depth and width of memory device **120** are fixed, so if it is desired to use a memory configuration other than the 1K×2 configuration of FIG. 2, memory device **120** cannot be used.

A variable depth and width memory circuit **146** in accordance with the present invention is shown in FIG. 3. Memory circuit **146** has a two kilobit RAM array **148**, which has 64 rows and 32 columns of memory cells **150**. Only one

memory cell **150** is shown in FIG. 3 to avoid over-complicating the drawing. Data may be written into memory cells **150** of array **148** using data input line **152**. Data is read out of the memory cells via one or more of eight data output lines **154**.

The number of data output lines **154** on which data is provided depends on the width selected for memory circuit **146**. If memory circuit **146** has been programmed to have a width of one (the ×1 mode), data is [provide] provided on a single one of the data output lines **154** (output line **D0**). If the programmed width is two (the ×2 mode), then data is provided using two data output lines **154** (output lines **D0** and **D1**). If the width is four (the ×4 mode) data is provided on data output lines **D0**, **D1**, **D2**, and **D3**. If the width is eight (the ×8 mode), data is provided on all eight of data output lines **154** (**D0–D7**).

The depth of memory circuit **146** varies depending on the chosen width of memory circuit **146**. For example, if the width is one, the depth is 2K. Widths of two, four, and eight result in depths of 1K, **[512, and 256]** *512, and 256*, respectively.

The depth and width of memory circuit **146** are preferably determined by a two-bit depth and width mode selection signal applied to input **156** of multiplexer decoder **158**. Multiplexer decoder **158** converts the two bit selection signal at input **156** to four depth and width control signals at output **160**. The depth and width control signals at output **160** are provided to multiplexers **162**, demultiplexers **164**, and address control logic **166**.

Address control logic **166** accepts a column address signal at input **168**. In the ×1 mode, a five bit column address is used in conjunction with a six bit row address to address individual memory cells **150**. In configurations of greater width, fewer bits of the column address are used. For example, in the ×2 mode, only a four bit column address is used. The four bit column address and the six bit row address are sufficient to specify a unique pair of memory cells **150** from which two data bits are obtained in parallel in the ×2 mode.

In the ×1 mode, all five bits of the column address supplied to input **168** are passed to column decoder **170**. In the ×2 mode, address control logic **166** provides four bits of the column address to column decoder **170** unchanged and assigns the fifth bit to a logical low signal. In the ×2 mode, the fifth bit of the column address at input **168** is therefore a “don’t care” bit. In the ×4 mode, address control logic **166** provides three bits of the column address to column decoder **170** unchanged and provides the fourth and fifth bits as logical low signals. The fourth and fifth bits of the column address at input **168** are don’t care bits in the ×4 mode. In the ×8 mode, address control logic **166** passes two bits of the column address at input **168** to column decoder **170** unchanged and provides the third, fourth, and fifth bits as logical low signals. The third, fourth, and fifth bits of the column address at input **168** are don’t care bits in the ×8 mode. Because address control logic **166** provides column decoder **170** with logical low signals when certain column address bits are not used, column decoder **170** addresses the appropriate column decoder output lines in routing array **173**.

Column decoder **170** decodes the address signals provided at input **172** by address control logic **166** and provides a corresponding decoder output signal on output lines **174**. Output lines **174** are connected to multiplexers **162** by 32 columns of input routing lines **176**. A pattern of fixed connections **178** is used to connect output lines **174** to input

routing lines 176. The illustrative pattern of fixed connections 178 shown in FIG. 3 allows output lines 174 to be connected to input routing lines 176 using a minimal amount of integrated circuit surface area. Multiplexers 162 connect the rightmost of the four input routing lines 176 in each of the 32 columns to column select lines 180 when the $\times 1$ mode is selected. Multiplexers 162 connect the input routing lines 176 that are second from the right in each of the 32 columns to the corresponding column select lines 180 when the $\times 2$ mode is selected. In the $\times 4$ and $\times 8$ modes, multiplexers 162 respectively direct the third and fourth input routing lines 176 from the right in each column to the column select lines 180. Column select lines 180 drive the gates of pass transistors 182.

When column addresses are provided to input 168, one or more column select lines 180 go high, depending on the selected mode of memory circuit 146. For example, if it is desired to operate memory circuit 146 in the $\times 1$ mode, the depth and width mode selection signal applied to multiplexer decoder 158 results in control signals at output 160 that direct address control logic 166 to pass the complete five bit column address signal applied to input 168 to column decoder 170. If the five bits of the column address signal are high, low, low, low, and low in the $\times 1$ mode, for example, the column decoder 170 will generate a logical high signal on the 0th (top) output line 174. The 0th output line 174 is connected to a number of multiplexers 162, such as multiplexer 162 in column 5 (via the $\times 8$ input) and multiplexer 162 in column 3 (via the $\times 8$ and $\times 4$ inputs). However, only in column 0 is the 0th output line 174 connected to the $\times 1$ input of one of multiplexers 162. Accordingly, in the $\times 1$ mode only the column select line 180 in column 0 goes high.

When the column select line 180 in column 0 goes high, pass transistor 182 in column 0 is turned on, so that data in column 0 is provided to the demultiplexer 164 in column 0. Demultiplexers 164 are connected to output data lines 154 by output routing lines 184. Output data lines 154 and output routing lines 184 are connected by a pattern of fixed connections 186 in the form of routing array 187. If data is passed from RAM array 148 via the pass transistor 182 in column 0 in the $\times 1$ mode, the data passes from demultiplexer 164 in column 0 to data output line [DO] D0 via the connection 186 at the intersection of the $\times 1$ output of demultiplexer 164 and data output line D0. Data output lines D1–D7 are not connected to RAM array 148 in the $\times 1$ mode.

If it is desired to operate memory circuit 146 in the $\times 2$ mode, the user of memory circuit 146 provides a four bit address to the first four input terminals of address control logic 166. An appropriate depth and width mode selection signal is applied to multiplexer decoder 158, which results in control signals at output 160 that direct address control logic 166 to pass a four bit column address to column decoder 170.

If the four bits of the column address signal in the $\times 2$ mode are high, low, low, and low, column decoder 170 will generate a logical high signal on the 0th (top) output line 174. Because the 0th output line 174 is connected to the $\times 2$ input of multiplexers 162 in both column 0 and column 1, the column select lines 180 in column 0 and column 1 both go high, turning on pass transistors 182 in column 0 and column 1. Because pass transistors 182 in column 0 and column 1 are on, data bits from memory cells in column 0 and column 1 are provided in parallel to the demultiplexers 164 in column 0 and column 1. Output routing lines 184

connect the outputs of the demultiplexers 164 in column 0 and column 1 to output data lines D0 and D1. Data output lines D2–D7 are not connected to RAM array 148 in the $\times 2$ mode.

At the same time that the column address is used to address data in one or more columns of RAM array 148, row decoder 190 accepts a six bit row address signal at input 192 that is used to address a selected one of the 64 rows of memory cells 150 in array 148. Output lines 194 of row decoder 190 drive 32 1:2 read/write demultiplexers 196, which receive a read/write select signal via line 198. If data is to be read from RAM array 148, demultiplexers 196 direct the signal from lines 194 to read word lines 200. If data is to be written to RAM array 148, demultiplexers 196 direct the signal from lines 194 to write word lines 202. A variety of different designs may be used for memory cell 150. If desired, a memory cell 150 that is addressed by a single word line and a single bit line may be used.

As shown in FIG. 4, each memory cell 150 preferably has an associated vertical write bit line 204, which provides data to be written into memory cell 150 from data input line 152 (FIG. 3). Data is read out of memory cell 150 using read bit line 206. Write bit line 204 and read bit line 206 are data lines. Read word line 200, write word line 202, and column select line 180 are address lines.

Data is stored in storage element 208, which may be based on [e.g.] e.g., dynamic RAM (DRAM), static RAM (SRAM), erasable programmable read-only memory (EPROM), electrically-erasable programmable read-only memory (E²PROM), flash memory, or any other suitable addressable memory technology. Preferably, storage element 208 is a four transistor SRAM cell that stores a single data bit.

In order to write a data bit into storage element 208, write word line 202 and column select line 180 are placed in a high logical state. Each memory cell 150 contains a transistor 210, which is turned on when write word line 202 is high. Each column of memory cells 150 contains a transistor 212, which is turned on when column select line 180 is high. Because transistors 210 and 212 are on when write word line 202 and column select line 180 are high, the data bit passes from data input line 152 to storage element 208 via write bit line 204. Read word line 200 is low, so transistor 214 is off.

To read a data bit from storage element 208, read word line 200 and column select line 180 are placed in a logical high state, which turns on transistor 214 and pass transistor 182. Because transistor 214 and pass transistor 182 are on, the data bit passes from storage element 208 to data out terminal 216. Buffer 218 is used to increase the signal strength of the data bit on line 206. Write word line 202 is low, so transistor 210 is off.

The foregoing is merely illustrative of the principles of this invention and various modifications can be made by those skilled in the art without departing from the scope and spirit of the invention. For example, the memory circuit can have different numbers of rows and columns of memory cells and the circuitry used to address the memory cells can be any suitable size.

What is claimed is:

1. A programmable variable depth and width random-access memory circuit, comprising:
 - a random-access memory array having a plurality of rows and columns of memory cells for storing data;

7

a plurality of data output lines;
 a row decoder connected to said random-access memory array for addressing said rows of memory cells;
 column address circuitry having a column decoder connected to said random-access memory array for addressing said columns of memory cells, said column address circuitry receiving a mode selection signal indicative of a desired depth and width for said memory circuit, said column address circuitry simultaneously addressing a predetermined number of said columns based on said mode selection signal, said predetermined number being equal to said desired width; and
 output circuitry connected to said random-access memory array for providing said data from said random-access memory array to said predetermined number of said data output lines.

2. The memory circuit of claim 1 wherein said column address circuitry further comprises:

a plurality of column decoder output lines connected to said column decoder for receiving column decoder output signals;
 a plurality of groups of input routing lines;
 a plurality of fixed connections between said column decoder output lines and said input routing lines for routing said column decoder output signals from said column decoder output lines to said input routing lines;
 a plurality of multiplexers each having a plurality of multiplexer inputs connected to one of said groups of input routing lines and a multiplexer output; and
 a plurality of column selection lines each connected to one of said multiplexer outputs and being associated with a respective one of said columns of said memory cells.

3. The memory circuit of claim 2 further comprising a plurality of pass transistors each having a gate terminal connected to one of said column selection lines, a pass transistor input terminal connected to one of said columns of memory cells, and a pass transistor output terminal.

4. The memory circuit of claim 3 wherein said output circuitry further comprises:

a plurality of groups of output routing lines;
 a plurality of demultiplexers each having a demultiplexer input connected to a respective one of said pass transistor output terminals and each having a plurality of demultiplexer outputs connected to one of said groups of output routing lines; and
 a plurality of fixed connections between said output routing lines and said data output lines.

5. The memory circuit of claim 4 wherein said demultiplexers receive said mode selection signal and selectively pass said data from said demultiplexer inputs to said demultiplexer outputs based on said mode selection signal.

6. The memory circuit of claim 2 wherein said multiplexers receive said mode selection signal and selectively pass said column decoder output signals from said multiplexer inputs to said multiplexer outputs based on said mode selection signal.

7. The memory circuit of claim 1 wherein said column address circuitry further comprises control logic for receiving a column address signal and said mode selection signal, said control logic providing said column address signal to said column decoder and providing at least one logical signal of a predetermined fixed value to said column decoder when said mode selection signal indicates that said width is at least two.

8

8. A method of programmably varying the depth and width of a random-access memory circuit having a random-access memory array with a plurality of rows and columns of memory cells, a plurality of data output lines, a row decoder, and column address circuitry containing a column decoder, the method comprising the steps of:

storing data in said memory cells;
 addressing said rows of memory cells with said row decoder;
 receiving a mode selection signal with said column address circuitry that is indicative of a desired depth and width for said memory circuit;
 simultaneously addressing a predetermined number of said columns with said column address circuitry based on said mode selection signal, said predetermined number being equal to said desired width; and
 providing said data from said random-access memory array to said predetermined number of said data output lines.

9. The method of claim 8 wherein said memory circuit further comprises a plurality of column decoder output lines connected to said column decoder, a plurality of groups of input routing lines, a plurality of fixed connections between said column decoder output lines and said input routing lines, and a plurality of multiplexers each having a multiplexer output and each having a plurality of inputs connected to one of said groups of input routing lines, the method further comprising the steps of:

receiving column decoder output signals from said column decoder with said column decoder output lines;
 routing said column decoder output signals from said column decoder output lines to said multiplexer inputs with said fixed connections and said input routing lines; and
 passing said column decoder output signals from said multiplexer inputs to said multiplexer outputs.

10. The method of claim 9 wherein said memory circuit further comprises a plurality of column selection lines each connected to one of said multiplexer outputs, the method further comprising the steps of:

receiving said column decoder output signals from said multiplexer outputs with said column selection lines; and
 simultaneously addressing said predetermined number of columns with said column selection lines.

11. The method of claim 10 wherein said memory circuit further comprises a plurality of pass transistors, the method further comprising the step turning on said predetermined number of said pass transistors to provide said data from said predetermined number of columns.

12. The method of claim 11 wherein said memory circuit further comprises a plurality of groups of output routing lines, a plurality of demultiplexers each having a demultiplexer input and each having a plurality of demultiplexer outputs connected to one of said groups of output routing lines, and a plurality of fixed connections, the method further comprising the steps of:

receiving said data from said pass transistor output terminals with said demultiplexer inputs;
 passing said data from said demultiplexer inputs to said demultiplexer outputs; and

9

routing said data from said demultiplexer outputs to said data output lines via said fixed connections and said output routing lines.

13. The method of claim **12** further comprising the steps of:

receiving said mode selection signal with said demultiplexers; and

selectively passing said data from said demultiplexer inputs to said demultiplexer outputs based on said mode selection signal.

14. The method of claim **9** further comprising the steps of: receiving said mode selection signal with said multiplexers; and

10

selectively passing said column decoder output signals from said multiplexer inputs to said multiplexer outputs based on said mode selection signal.

15. The method of claim **8** wherein said column address circuitry comprises control logic, the method further comprising the steps of:

receiving a column address signal and said mode selection signal with said control logic; and

providing said column address signal and at least one logical signal of a predetermined fixed value to said column decoder with said control logic when said mode selection signal indicates that said width is at least two.

* * * * *